

标 记 MARK	ECN编号/变更内容 ECN NO/DEFINITION	修 改 REVISE	日 期 DATE	核 准 APPROVE

A

B

C

D

E

F

G

A

B

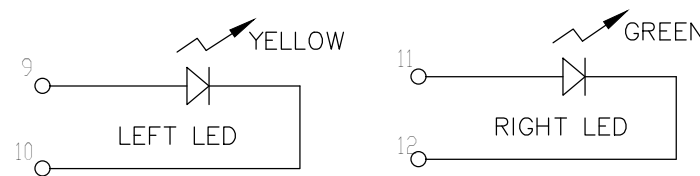
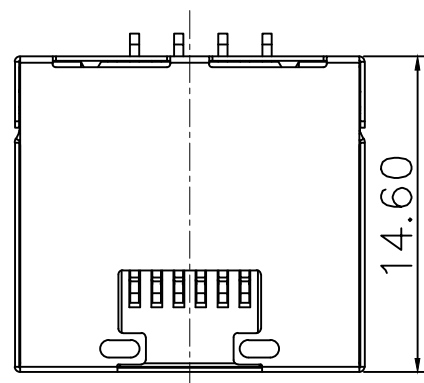
C

D

E

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G



NOTES:

MATERIAL

- 1.HOUSING MATERIAL: LCP BLACK
2.CONTACT MATERIAL: C5191 R-H,T=0.30mm
3.SHELL: BRASS R-H ,T=0.2mm

FINISH:

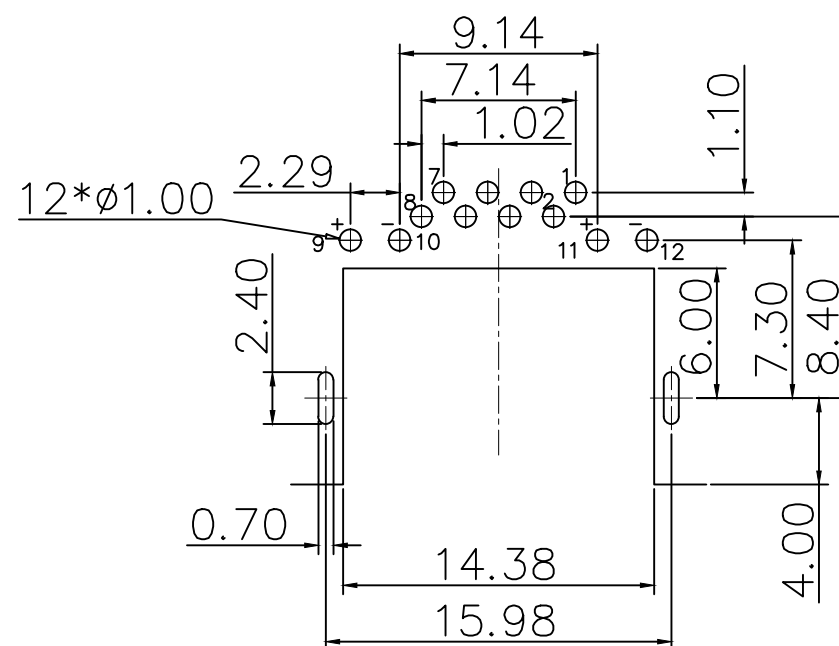
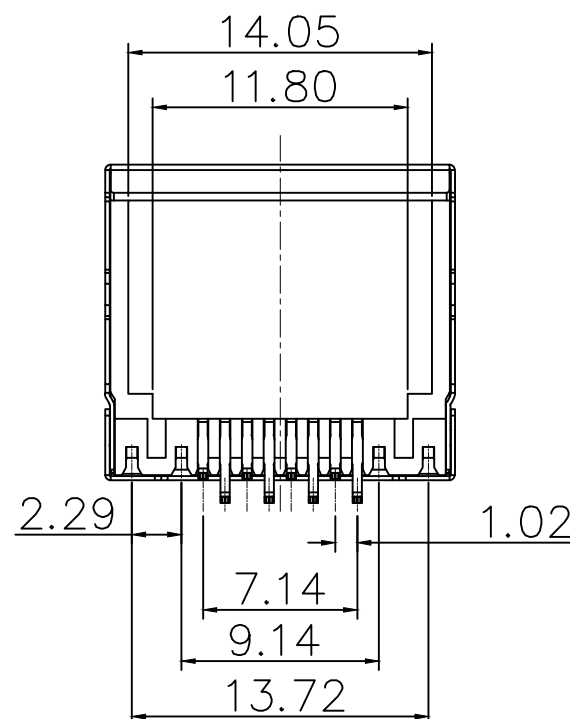
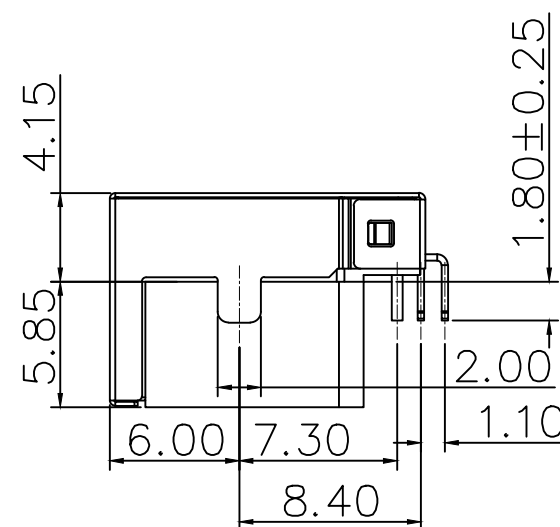
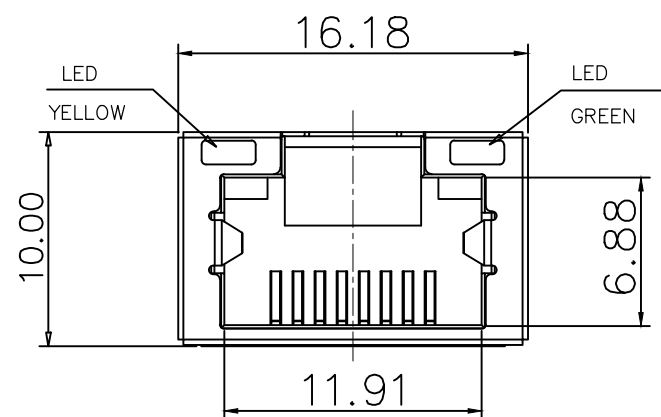
- 1.CONTACT PLATING: 50u" MIN. NICKEL PLATED UNDER ALLOVER
80u" MIN. TIN PLATED IN SOLDERING AREA
GOLD PLATED IN CONTACT AREA
2.SHELL PLATING: 30u" MIN NICKEL PLATED ALLOVER

ELECTRICAL:

- 1.VOLTAGE RATING: 125 VAC RMS
2.CURRENT RATING: 1.5 AMP
3.CONTACT RESISTANCE: 30 MILLIOHMS MAX
4.INSULATION RESISTANCE: 500 MEGOHMS MIN @ 500V DC
5.DIELECTRIC WITHSTANDING VOLTAGE : 500V AC R.M.S MIN

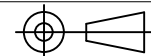
MECHANICAL:

- 1.DURRABILITY: 750 CYCLES MIN
2.PCB RETENTION PRE-SOLDER: 1 LB MIN.



RECOMMENDED P.C.B LAYOUT
TOP VIEW (COMPONENT SIDE)

3	外壳	铜	镀镍	
2	接触	铜	镀金G/F	
1	基座	LCP	黑色	
序号	品名	材质	电镀/颜色	备注

	深圳市虹成电子有限公司			品 名 TITLE	网 口	
				料 号 PART NO	HC-WK88-C415-DK	
UNLESS OTHERWISE, GENERAL TOLERANCE:		比 列 SCALE	1 : 1			
X. xxx ±0.10 X. xx ±0.20 X. x ±0.30		单 位 UNIT	MM	制 图 DRAW	AhYe	
ANGULAR: X. xx° ±1° X. x° ±3° X. ° ±5°		张 数 PART NO	1 OF 1	审 核 CHECKED	夏操云	
		版 本 REV	A	批 准 APPROVE	赵亮亮	

